# **NX5DV330**

# Quad 1-of-2 video multiplexer/demultiplexer Rev. 03 — 5 August 2009

Product data sheet

#### **General description** 1.

The NX5DV330 is a quad 1-of-2 high-speed TTL-compatible video multiplexer/demultiplexer. The low ON resistance of the switch allows inputs to be connected to outputs without adding propagation delay or generating additional ground bounce noise

It has a digital select input (S), four independent inputs/outputs (nY0, nY1), a common input/output (nZ) and an active LOW enable input (E). When pin E is HIGH, the switch is turned off.

Schmitt-trigger action at the enable input  $(\overline{E})$  and select input (S) makes the circuit tolerant to slower input rise and fall times across the entire  $V_{CC}$  range from 4.0 V to 5.5 V.

The NX5DV330 is characterized for operation from -40 °C to +85 °C.

#### 2. **Features**

- $\blacksquare$  5  $\Omega$  switch connection between two ports
- TTL-compatible input levels
- Minimal propagation delay through the switch
- ESD protection:
  - HBM JESD22-A114E Class 2A exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
  - CDM JESD22-C101C exceeds 1000 V
- Latch-up testing is done to JEDEC standard JESD78 which exceeds 100 mA



## Quad 1-of-2 video multiplexer/demultiplexer

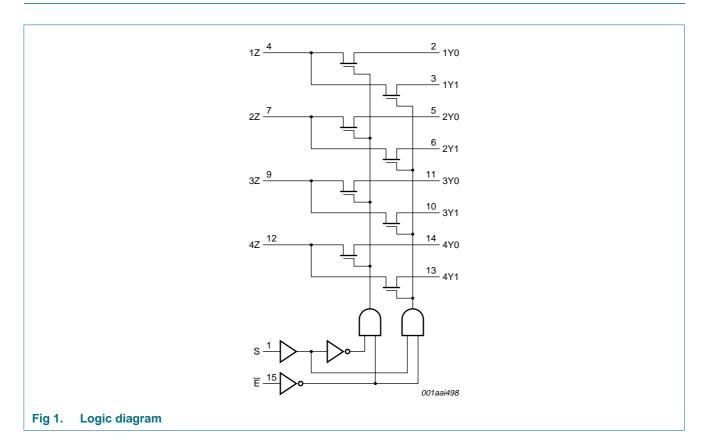
# 3. Ordering information

Table 1. Ordering information

Type number	Package	Package										
	Temperature range	Name	Description	Version								
NX5DV330D	–40 °C to +85 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1								
NX5DV330DS	–40 °C to +85 °C	SSOP16[1]	plastic shrink small outline package; 16 leads; body width 3.9 mm; lead pitch 0.635 mm	SOT519-1								
NX5DV330PW	–40 °C to +85 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1								
NX5DV330BQ	–40 °C to +85 °C	DHVQFN16	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body $2.5\times3.5\times0.85$ mm	SOT763-1								

<sup>[1]</sup> Also known as QSOP16.

# 4. Functional diagram

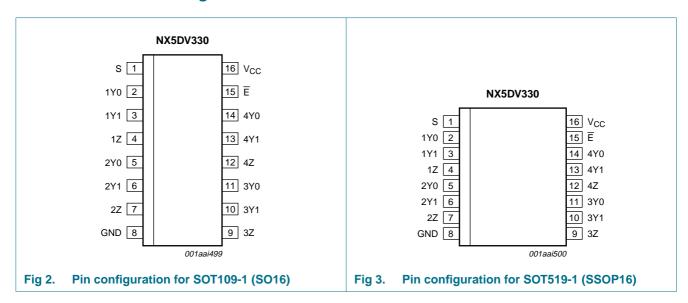


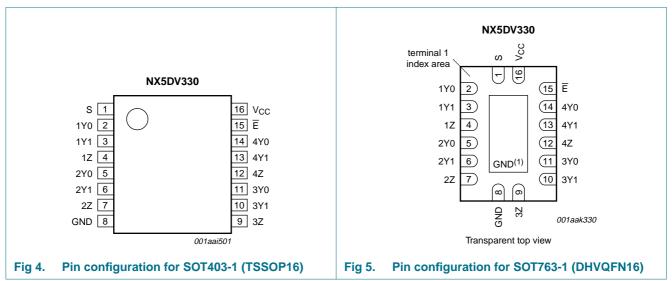
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# 5. Pinning information

### 5.1 Pinning





#### 5.2 Pin description

Table 2. Pin description

- In the second		
Symbol	Pin	Description
S	1	select control input
1Y0, 1Y1, 2Y0, 2Y1, 3Y1, 3Y0, 4Y1, 4Y0	2, 3, 5, 6, 10, 11, 13, 14	independent input or output
1Z, 2Z, 3Z, 4Z	4, 7, 9, 12	independent input or output
GND	8	ground (0 V)
Ē	15	enable input (active LOW)
Vcc	16	positive supply voltage

#### Quad 1-of-2 video multiplexer/demultiplexer

## 6. Functional description

Table 3. Function selection

 $H = HIGH \ voltage \ level; \ L = LOW \ voltage \ level; \ X = Don't \ care.$ 

Input		Switch
Ē	S	
L	L	Y0 to Z or Z to Y0
L	Н	Y1 to Z or Z to Y1
Н	X	switch off

## 7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		-0.5	+7.0	V
$V_{I}$	input voltage		<u>[1]</u> –0.5	+7.0	V
I <sub>SW</sub>	switch current	continuous current through each switch	-	128	mA
$I_{IK}$	input clamping current	$V_1 < 0 V$	-	-50	mA
$T_{stg}$	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation		[2][3][4]	500	mW

<sup>[1]</sup> The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.

# 8. Recommended operating conditions

Table 5. Operating conditions

All unused control inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{CC}$	supply voltage		4.0	5.0	5.5	V
$V_{IH}$	HIGH-level input voltage		2.0	-	-	V
$V_{IL}$	LOW-level input voltage		-	-	0.8	V
$V_{H}$	hysteresis voltage	pin S, Ē	-	45	-	mV
$T_{amb}$	ambient temperature	operating in free-air	-40	+25	+85	°C

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<sup>[2]</sup> For SO16 package: Ptot derates linearly with 8 mW/K above 70 °C.

<sup>[3]</sup> For SSOP16 (QSOP16) and TSSOP16 packages: Ptot derates linearly with 5.5 mW/K above 60 °C.

<sup>[4]</sup> For DHVQFN16 packages: above 60 °C derate linearly with 4.5 mW/K.

#### Quad 1-of-2 video multiplexer/demultiplexer

## 9. Static characteristics

Table 6. Static characteristics

 $T_{amb} = -40 \,^{\circ}C$  to +85  $^{\circ}C$ .

anno						
Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
$V_{IK}$	input clamping voltage	$V_{CC} = 4.5 \text{ V}; I_I = -18 \text{ mA}$	-	-	-1.2	V
l <sub>l</sub>	input leakage current	pin S, $\overline{E}$ ; V <sub>CC</sub> = 5.5 V; V <sub>I</sub> = GND or 5.5 V	-	-	±1	μΑ
I <sub>S(OFF)</sub>	OFF-state leakage current	$V_{CC}$ = 5.5 V; $V_I$ = GND; $V_O$ = 0 V to 5.5 V	-	-	±1	μΑ
I <sub>OFF</sub>	power-off leakage current	$V_{CC} = 0 \text{ V}; V_I = V_O = 0 \text{ V to } 5.5 \text{ V}$	-	-	±1	μΑ
I <sub>CC</sub>	supply current	$V_{CC}$ = 5.5 V; $I_O$ = 0 mA; $V_I$ = $V_{CC}$ or GND	-	-	3	μΑ
$\Delta I_{CC}$	additional supply current	pin S, $\overline{E}$ ; V <sub>CC</sub> = 5.5 V; one input at 3.4 V, other inputs at V <sub>CC</sub> or GND	[2] _	-	2.5	mA
Cı	input capacitance	pin S, $\overline{E}$ ; V <sub>I</sub> = 5 V or 0 V	-	3.5	-	pF
C <sub>io(off)</sub>	off-state input/output	Z port; $V_{CC} = 5 \text{ V}$ ; $V_{O} = 5 \text{ V}$ or 0 V; $\overline{E} = V_{CC}$	-	6.0	-	pF
	capacitance	Y port; $V_{CC} = 5 \text{ V}$ ; $V_{O} = 5 \text{ V}$ or $0 \text{ V}$ ; $\overline{E} = V_{CC}$	-	4.0	-	pF
C <sub>io(on)</sub>	on-state input/output capacitance	Z port; $V_{CC} = 5 \text{ V}$ ; $V_{O} = 5 \text{ V}$ or 0 V; $\overline{E} = \text{GND}$	-	14	-	pF
R <sub>ON</sub>	ON resistance	V <sub>CC</sub> = 4.5 V	[3]			
		$V_I = 1.0 \text{ V}; I_I = 13 \text{ mA}$	-	3	7	Ω
		$V_I = 2.0 \text{ V}; I_I = 26 \text{ mA}$	-	7	10	Ω

<sup>[1]</sup> All typical values are measured at  $V_{CC}$  = 5 V;  $T_{amb}$  = 25 °C.

# 10. Dynamic characteristics

Table 7. Dynamic characteristics

 $T_{amb} = -40 \,^{\circ}C$  to +85  $^{\circ}C$ ; for test circuit see Figure 7.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$t_{on}$	turn-on time	S to nZ; see Figure 6				
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	-	4.0	6.0	ns
$t_{\text{off}}$	turn-off time	S to nZ; see Figure 6				
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	nZ; see Figure 6 cc = 4.5 V to 5.5 V - 4.0 6.0 nZ; see Figure 6	6.0	ns	

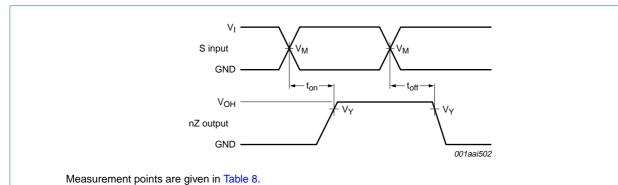
<sup>[2]</sup> This is the increase in supply current for each input that is at the specified TTL voltage level rather than  $V_{CC}$  or GND.

<sup>[3]</sup> Measured by the voltage drop between the Z and the Y terminals at the indicated current through the switch. ON-state resistance is determined by the lowest voltage of the two (Z or Y) terminals.

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## 11. Waveforms



 $\ensuremath{V_{\text{OH}}}$  is the typical voltage output level that occurs with the output load.

Input (S) to output (nZ) turn-on and turn-off time Fig 6.

Table 8. **Measurement points** 

Supply voltage	Input		Output
V <sub>CC</sub>	V <sub>I</sub>	V <sub>M</sub>	V <sub>Y</sub>
4.5 V to 5.5 V	GND to 3.0 V	1.5 V	0.9V <sub>OH</sub>

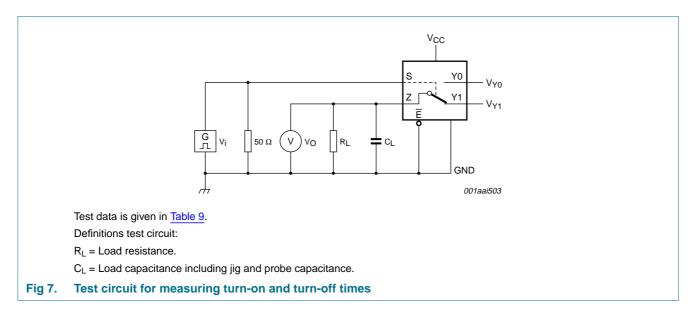


Table 9. Test data

Input		Load				
VI	fi	t <sub>r</sub> , t <sub>f</sub>	V <sub>Y0</sub>	V <sub>Y1</sub>	R <sub>L</sub>	CL
GND to 3.0 V	≤ 10 MHz	≤ 2.5 ns	GND to 3.0 V	3.0 V to GND	75 Ω	20 pF

#### Quad 1-of-2 video multiplexer/demultiplexer

## 12. Additional dynamic characteristics

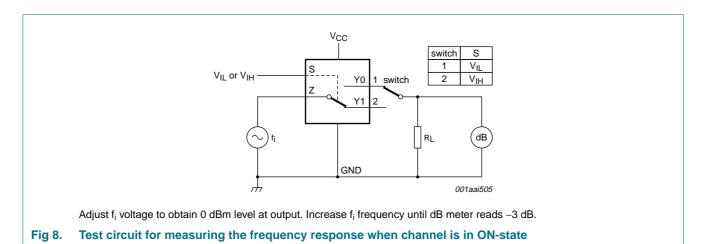
#### Table 10. Additional dynamic characteristics

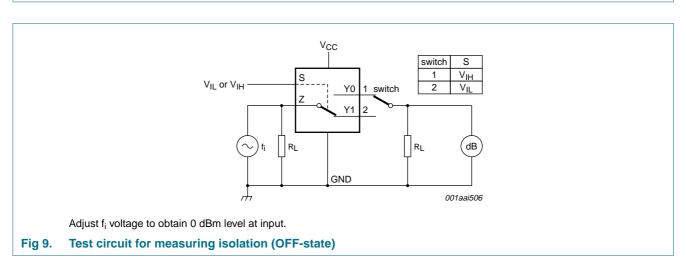
At recommended operating conditions; voltages are referenced to GND (ground = 0 V);  $V_l$  = GND or  $V_{CC}$  (unless otherwise specified);  $T_{amb}$  = 25 °C;  $V_{CC}$  = 4.5 V to 5.5 V.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$G_{dif}$	differential gain	$f_i = 3.58 \text{ MHz}; R_L = 150 \Omega$		-	0.64	-	%
φ <sub>dif</sub>	differential phase	$f_i = 3.58 \text{ MHz}; R_L = 150 \Omega$		-	0.1	-	deg
f <sub>(-3dB)</sub>	-3 dB frequency response	$R_L = 150 \Omega$ ; see Figure 8		300	-	-	MHz
$\alpha_{\text{iso}}$	isolation (OFF-state)	$f_i$ = 10 MHz; $R_L$ = 150 $\Omega$ ; see Figure 9		-	-60	-	dB
Xtalk	crosstalk	between switches; see Figure 10; $f_i = 10$ MHz; $R_L = 150 \Omega$ ; $R_i = 10 \Omega$	<u>[1]</u>	-	-63	-	dB

<sup>[1]</sup> All unused analog input pins (nZ) and outputs pins (nYn) are connected through 10  $\Omega$  and 50  $\Omega$  pull-down resistors, respectively.

#### 13. Test circuits





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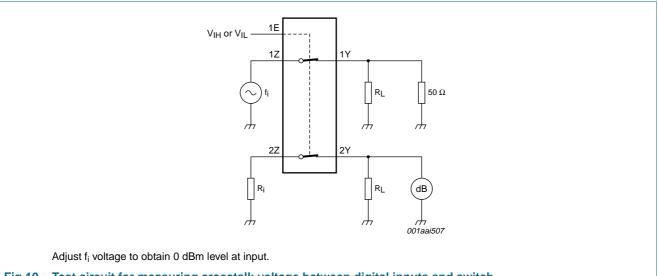


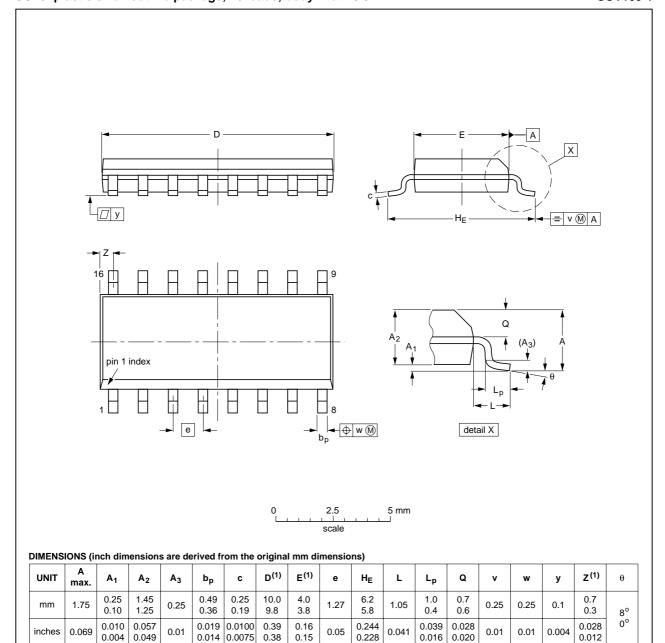
Fig 10. Test circuit for measuring crosstalk voltage between digital inputs and switch

#### Quad 1-of-2 video multiplexer/demultiplexer

# 14. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



#### Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE	
SOT109-1	076E07	MS-012			<del>99-12-27</del> 03-02-19	

Fig 11. Package outline SOT109-1 (SO16)

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SSOP16: plastic shrink small outline package; 16 leads; body width 3.9 mm; lead pitch 0.635 mm SOT519-1

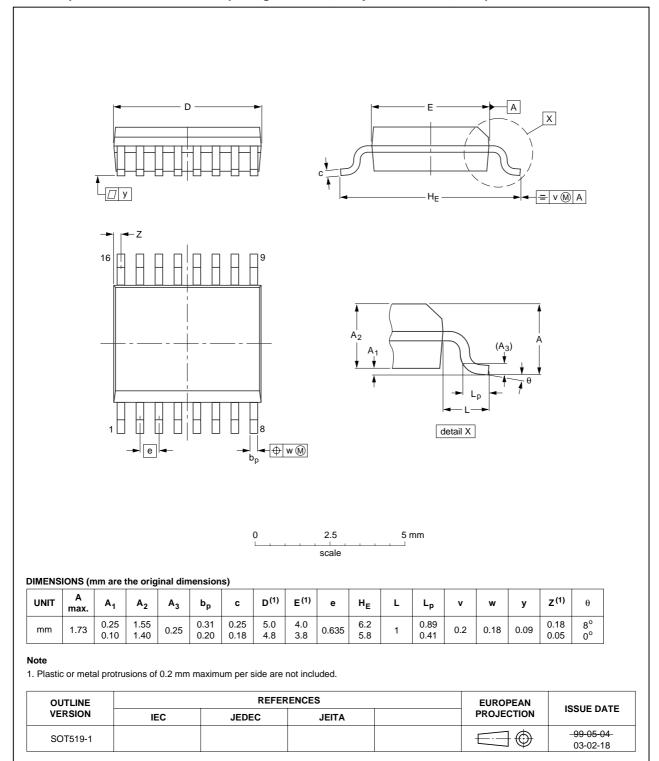


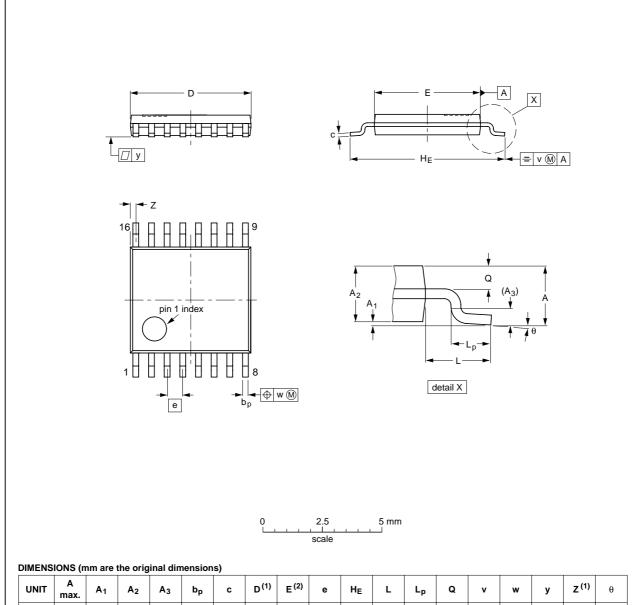
Fig 12. Package outline SOT519-1 (SSOP16)

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## Quad 1-of-2 video multiplexer/demultiplexer

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



UNI	Γ A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(2)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.40 0.06	8° 0°

#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN	ISSUE DATE
	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT403-1		MO-153				<del>99-12-27</del> 03-02-18
					- +	00 02 .0

Fig 13. Package outline SOT403-1 (TSSOP16)

Quad 1-of-2 video multiplexer/demultiplexer

DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm SOT763-1

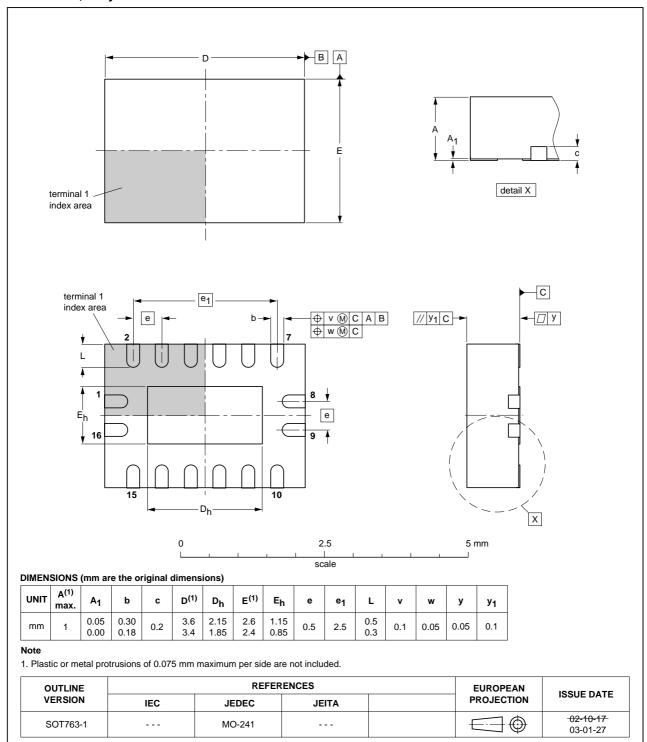


Fig 14. Package outline SOT763-1 (DHVQFN16)

Quad 1-of-2 video multiplexer/demultiplexer

## 15. Abbreviations

#### Table 11. Abbreviations

Acronym	Description
CDM	Charged Device Model
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

# 16. Revision history

#### Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
NX5DV330_3	20090805	Product data sheet	-	NX5DV330_2
Modifications:	<ul> <li>Added type n</li> </ul>	umber NX5DV330BQ (DHVQF	N16 package)	
NX5DV330_2	20080825	Product data sheet	-	NX5DV330_1
NX5DV330_1	20080815	Product data sheet	-	-

#### Quad 1-of-2 video multiplexer/demultiplexer

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#### 17.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions"
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## Quad 1-of-2 video multiplexer/demultiplexer

## 19. Contents

1	General description	. 1
2	Features	. 1
3	Ordering information	. 2
4	Functional diagram	. 2
5	Pinning information	. 3
5.1	Pinning	. 3
5.2	Pin description	. 3
6	Functional description	. 4
7	Limiting values	. 4
8	Recommended operating conditions	. 4
9	Static characteristics	. 5
10	Dynamic characteristics	. 5
11	Waveforms	. 6
12	Additional dynamic characteristics	. 7
13	Test circuits	
14	Package outline	. 9
15	Abbreviations	
16	Revision history	13
17	Legal information	
17.1	Data sheet status	
17.2	Definitions	
17.3	Disclaimers	
17.4	Trademarks	14
18	Contact information	14
10	Contents	15

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